



# Product Change Notification

## 112557 - 01

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**Americas Contact:** [asmo.pcn@intel.com](mailto:asmo.pcn@intel.com)

**Asia Pacific/PRC Contact:** [apacgccb@intel.com](mailto:apacgccb@intel.com)

**Europe Email:** [eccb@intel.com](mailto:eccb@intel.com)

**Japan Email:** [jccb.ijkk@intel.com](mailto:jccb.ijkk@intel.com)

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# Product Change Notification

**Change Notification #:** 112557 - 01

**Change Title:** Intel® SSD DC S3700 Series (100GB, 200GB, 400GB, 800GB) 1.8" and 2.5"  
PCN 112557-01, Label  
Update Labels

**Reason for Revision:** Internal Application Issues

**Date of Publication:** September 19, 2013

## Key Characteristics of the Change:

Label

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	Sep 20, 2013
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## Description of Change to the Customer:

**Reason for Revision:** Internal Application Issues

**This PCN was published internally on September 3, 2013. However, due to internal application issues, the PCN was not posted to the Intel Quality Document Management System (QDMS) to be available for viewing/downloading. Additionally, email notifications were not sent out to all applicable customers.**

**If there are any questions, please contact the Intel Representative(s) for your geographic location listed on page 2 of this PCN.**

Intel is updating the Solid State Drive labels on the Intel® SSD DC S3700 Series products (1.8" and 2.5") to include "Designed in USA" and the Canadian Regulatory String (see areas highlighted in red below):

1.8" Solid State Drive Label:

**Intel® SSD DC SXXXX Series XXXGB**

FW: XXXXXXXX

SA: XXXXXX-XXX  
PBA: XXXXXX-XXX  
LBA XXX,XXX,XXX  
Pb-free 2LI






Intel Corporation  
Attn: Corporate Quality  
2200 Mission College Blvd.  
Santa Clara, CA 95054-1549  
USA WO: XXXXXXXX






**CAN ICES-3(B)/NMB-3(B)** WWN: XXXXXXXXXXXXXXXX

Model: SSDXXXXXXXXXX  
1.8" XGb/s SATA SSD XXXG 3.3V 1A

Disclaimer: WARRANTY VOID IF ANY LABEL/  
SCREW IS REMOVED OR BROKEN

Designed in USA, assembled in China.

2.5" Solid State Drive Label:

**Intel® SSD DC SXXXX Series XXXGB**

ISN: XXXXXXXXXXXXXXXX

VDC AMPS  
+5V 1.44A  
+12V 0.6A

SA: XXXXXX-XXX  
PBA: XXXXXX-XXX  
LBA XXX,XXX,XXX  
Pb-free 2LI

WO: XXXXXXXX  
FW: XXXXXXXX

Intel Corporation  
Attn: Corporate Quality  
2200 Mission College Blvd.  
Santa Clara, CA 95054-1549  
USA






**CAN ICES-3(B)/NMB-3(B)** WWN: XXXXXXXXXXXXXXXX




Model: SSDXXXXXXXXXX  
2.5" XGb/s SATA SSD XXXG

Disclaimer: WARRANTY VOID IF ANY LABEL/  
SCREW IS REMOVED OR BROKEN

Designed in USA, assembled in China.



## Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers.

Milestone dates are estimates and subject to change based on business and operational conditions.

## Products Affected / Intel Ordering Codes:

Product Code	MM#
SSDSC2BA100G301	921632
SSDSC2BA200G301	921634
SSDSC2BA400G301	921636
SSDSC2BA800G301	921638
SSDSC1NA200G301	922137
SSDSC1NA400G301	922138
SSDSC2BA100G3	925878
SSDSC2BA200G3	925879
SSDSC2BA400G3	925880
SSDSC2BA800G3	925882
SSDSC1NA200G3	929439
SSDSC1NA400G3	929440

## PCN Revision History:

Date of Revision:	Revision Number:	Reason:
September 3, 2013	00	Originally Published PCN
<a href="#">September 19, 2013</a>	<a href="#">01</a>	<a href="#">Internal Application Issues</a>